FORM PTO-1595	RECOR	101591928	U.S. DEPARTMENT OF COMMERCE	
1/31/92 Office / . // . // .	F		Patent and Trademark	
To the Honorable Commission thereof.	oner of Patents and	Trademarks: Please Record the attac	ched original documents or copy	
1, Name of conveying party(ies): ERIKO MATSUI AKIRA ISHIBASHI YOSHIFUMI MORI Additional name(s) of conveying party(ies) attached? □ Yes ⋈ No		2. Name and address Name: <u>Sony Corp</u>		
		Shinagawa-ku	agawa 6-chome , Tokyo 141, Japan	
			Street Address:	
3. Nature of conveyance:		City:	State:Zip:	
☐ Security AgreementName☐ OtherExecution Date <u>December</u>	per 20 & 21, 2000	of	and the second of the second o	
4. Application (number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is:				
A. Patent Application U.S. Serial No. 09 Old Attorney Docket	/616,687 filed Jul ket No. P00,1015	1 1 1 1	FAN 1 1 2001	
Additional numbers atta	ched? ☐ Yes ⊠	l No	Use the search notants involved	
5. Name and address of party to whom correspondence concerning document should be mailed:		7. Total Fee (37 CFR 3		
SONNENSCHEIN NA P.O. Box #061080		HAL ⊠ Authorized to be Additional fees	charged to deposit account any	
Wacker Drive Station Sears Tower Chicago, IL 60606-1080 Customer ID No. 26263		8. Deposit Account N 19.3140 (Attach duplicate copy of	umber: this page if paying by deposit account)	
DO NOT USE THIS	SPACE			
9. Statement and signate To the best of my knowle copy is a true copy of the David R. Metzger Name of Person S	e original as	the foregoing information is true in ment. Signature	January 9, 2001 Date Total number of pages 3	
Mail documents to be recorded and required cover sheet information to: Commissioner of Patents and Trademarks Box Assignments Washington, D.C. 20231+				
	1			

01/23/2001 GTON11 00000189 09616687 01 FC:581 40.00 0

Docket Number: P00,1015

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in OPTICAL DEVICE.

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/616.687 Filing Date: 7/14/2000

This assignment executed on the dates indicated below.

ERIKO MATSUI	Execution date of U.S. Patent Application
Name of first or sole inventor	
KANAGAWA. JAPAN Residence of first or sole inventor Eriko Matsin	December 20, 2000 Date of this assignment
Signature of first or sole inventor	

PATENT REEL: 011441 FRAME: 0426

AKIRA ISHIBASHI	
Name of second inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN	
Residence of second inventor	21 Dec. 2000
Signature of second inventor	Date of this assignment
YOSHIFUMI MORI Name of third inventor	Execution date of U.S. Patent Application
CHIBA, JAPAN Residencenof third inventor	
Hostoffee Mon-	21 Dec. 2000
Signature of third inventor	Date of this assignment
Name of fourth inventor	Execution date of U.S. Patent Application
Name of fourth inventor	
Residence of fourth inventor	
	Date of this assignment
Signature of fourth inventor	
	Execution date of U.S. Patent Application
Name of fifth inventor	
Residence of fifth inventor	
	Date of this assignment
Signature of fifth inventor	

RECORDED: 01/11/2001

PATENT REEL: 011441 FRAME: 0427